

Dual N-Channel 20V(D-S) MOSFET, ESD Protection

GENERAL DESCRIPTION

The ME6986ED is the Dual N-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

FEATURES

- $R_{DS(ON)} \leq 13.5m\Omega @ V_{GS}=4.5V$
- $R_{DS(ON)} \leq 18m\Omega @ V_{GS}=2.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

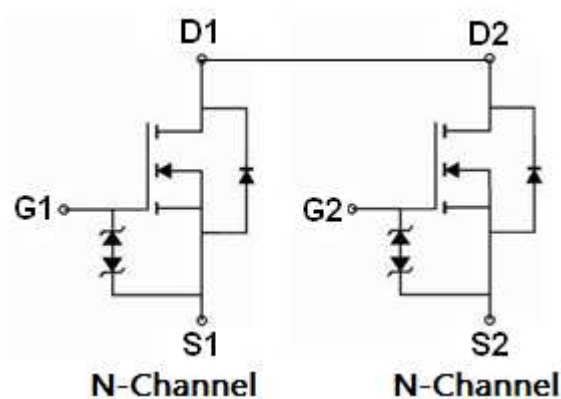
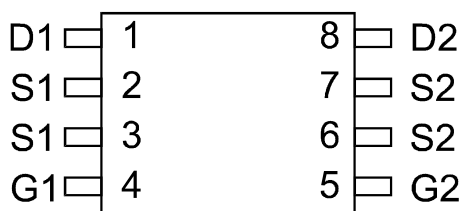
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- Load Switch
- DSC

PIN CONFIGURATION

(TSSOP-8)

Top View



Ordering Information: ME6986ED (Pb-free)

ME6986ED-G (Green product-Halogen free)

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ Unless Otherwise Noted)

Parameter		Symbol	Maximum Ratings	Unit
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	± 12	V
Continuous Drain Current	$T_A=25^\circ\text{C}$	I_D	7.6	A
	$T_A=70^\circ\text{C}$		6	
Pulsed Drain Current		I_{DM}	30	A
Maximum Power Dissipation	$T_A=25^\circ\text{C}$	P_D	1.2	W
	$T_A=70^\circ\text{C}$		0.8	
Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient*		$R_{\theta JA}$	100	$^\circ\text{C/W}$

* The device mounted on $1in^2$ FR4 board with 2 oz copper

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Electrical Characteristics (T_J=25°C Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250 μA	20			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250 μA	0.5		1.5	V
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±10V			±10	uA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =16V, V _{GS} =0V			1	μA
R _{DS(ON)}	Drain-Source On-State Resistance ^a	V _{GS} =4.5V, I _D = 5A		11	13.5	mΩ
		V _{GS} =2.5V, I _D = 3A		13.5	18	
V _{SD}	Diode Forward Voltage	I _S =1.7A, V _{GS} =0V		0.75	1.2	V
DYNAMIC						
Q _g	Total Gate Charge	V _{DS} =10V, V _{GS} =4V, I _D =5A		13.8		nc
Q _{gs}	Gate-Source Charge			3.0		
Q _{gd}	Gate-Drain Charge			4.8		
C _{iss}	Input Capacitance	V _{DS} =8V, V _{GS} =0V, f=1MHz		794		pF
C _{oss}	Output Capacitance			182		
C _{rss}	Reverse Transfer Capacitance			144		
t _{d(on)}	Turn-On Delay Time	V _{DD} =10V, R _L =10Ω V _{GEN} =4V, R _G =10Ω		28.5		ns
t _r	Turn-On Rise Time			35.8		
t _{d(off)}	Turn-Off Delay Time			89		
t _f	Turn-Off Fall Time			19.2		

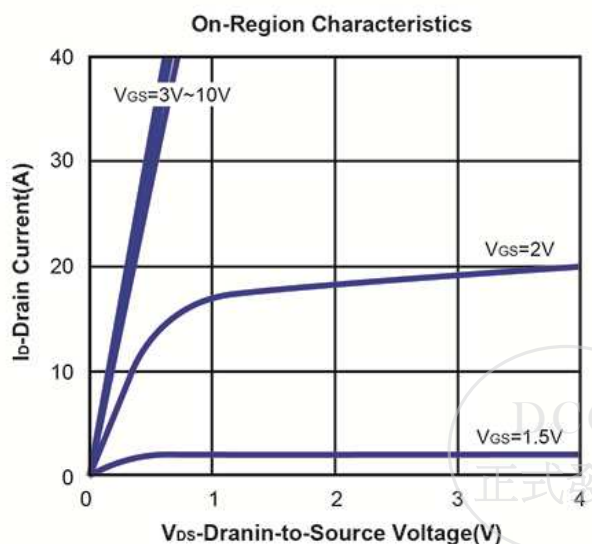
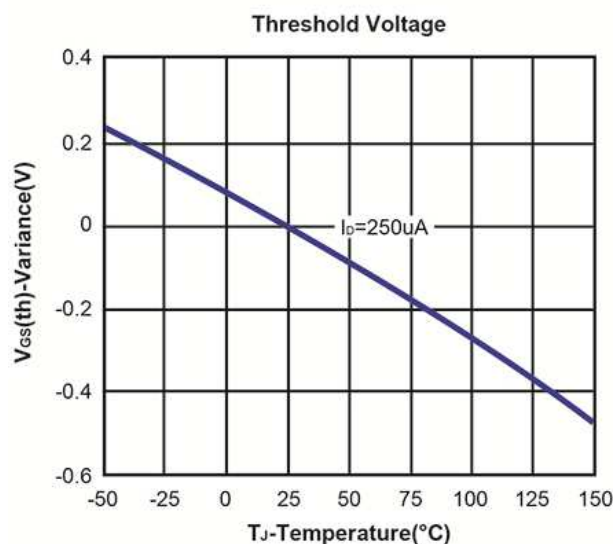
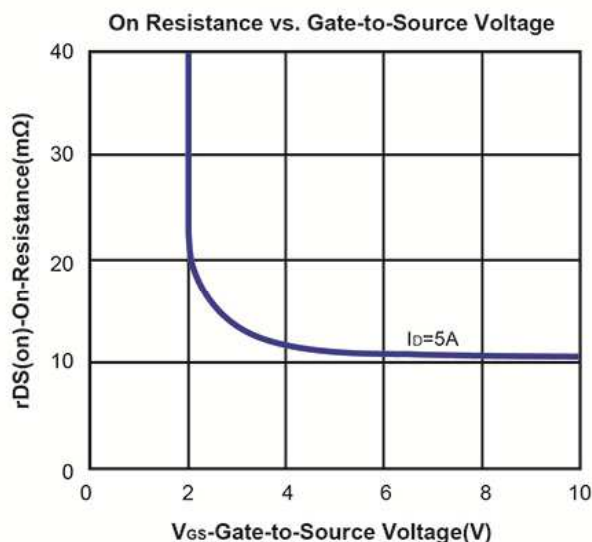
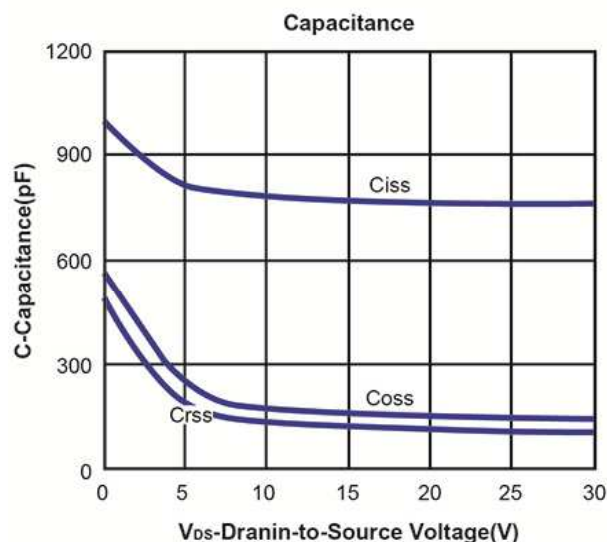
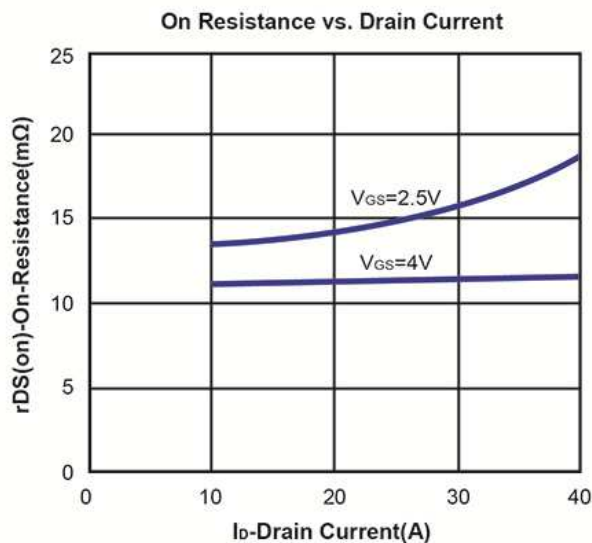
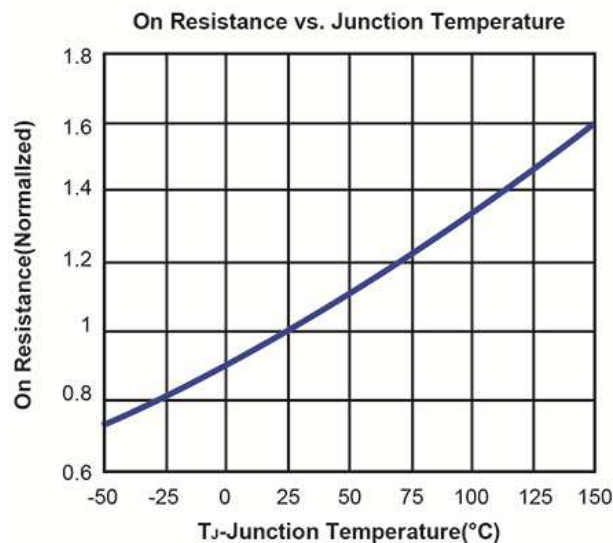
Notes: a. Pulse test: pulse width ≤ 300us, duty cycle ≤ 2%, Guaranteed by design, not subject to production testing.

b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.

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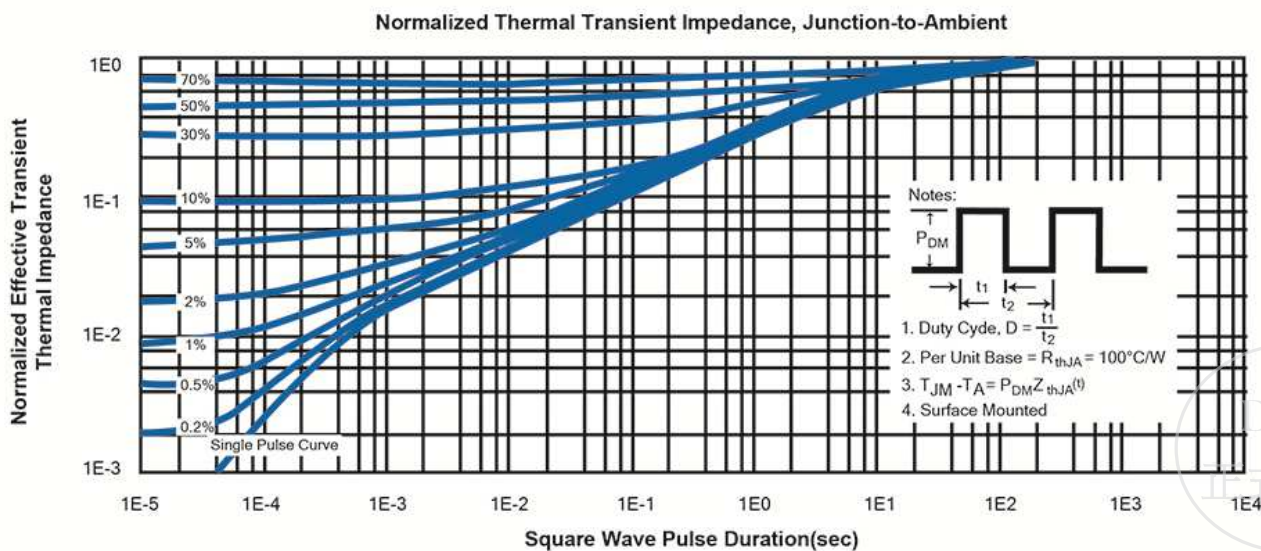
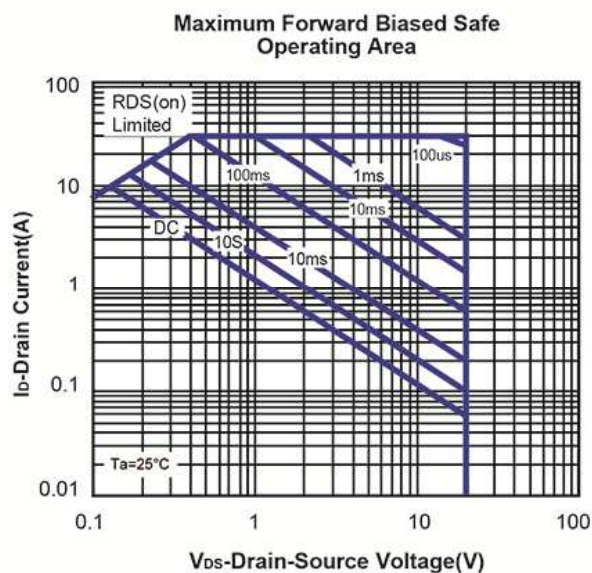
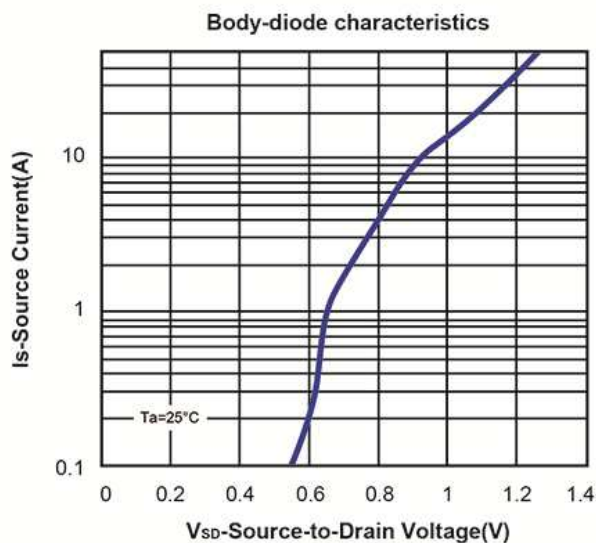
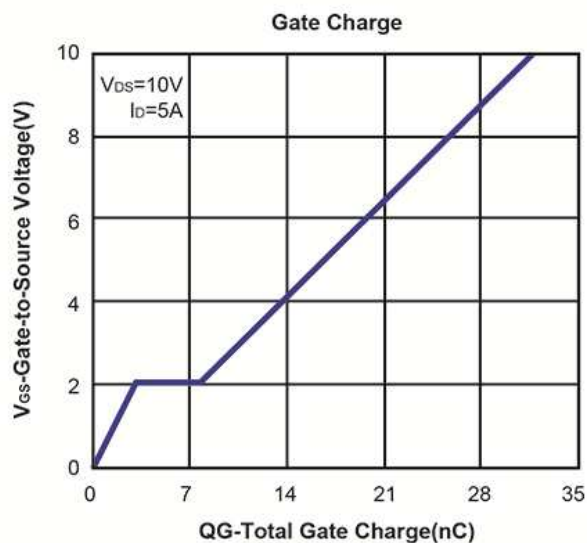
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Typical Characteristics (T_J =25°C Noted)

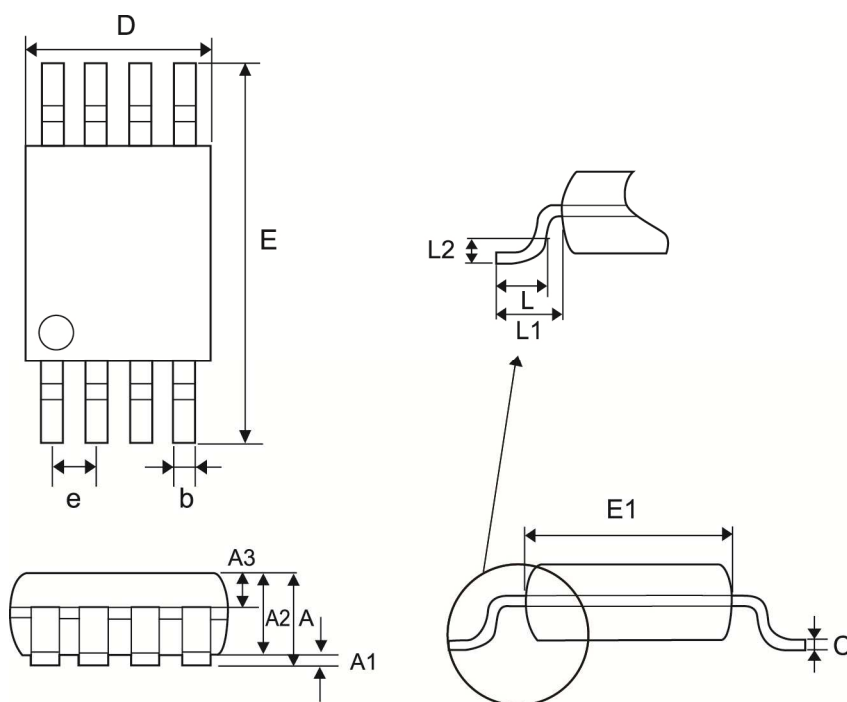


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TSSOP-8 Package



Symbol	MILLIMETERS (mm)	
	MIN	MAX
A	-	1.20
A1	0.05	0.15
A2	0.90	1.05
A3	0.34	0.54
b	0.19	0.30
c	0.09	0.20
D	2.90	3.10
E	6.20	6.60
E1	4.30	4.50
e	0.65 BSC	
L	0.45	0.75
L1	1.00 REF	
L2	0.25 BSC	

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